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Attorney Docket No.: **DIS-P016**First Named Inventor: **Jiuzhi Xue****EJ829449407US**

Jay R Beyer

UTILITY PATENT APPLICATION TRANSMITTAL (37 CFR § 1.53(b))

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Sir: This is a request for filing a patent application under 37 CFR. § 1.53(b) in the name of inventors:
Jiuzhi Xue, Beth L. Ellis, Stephen H. Perlmutter, and Charles Crandall

For: **CHEVRON-FREE FLC DEVICE**Application Elements:

- ☒ **15** Pages of Specification, Claims and Abstract
☒ **5** Sheets of **formal** Drawings
☒ **4** Pages Combined Declaration and Power of Attorney

Accompanying Application Parts:

- ☐ Assignment and Assignment Recordation Cover Sheet (recording fee of \$40.00 enclosed)
☐ 37 CFR 3.73(b) Statement by Assignee
☐ Information Disclosure Statement with Form PTO-1449
☐ Copies of IDS Citations
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Fee Calculation (37 CFR § 1.16)

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	<u>NO. FILED</u>	<u>NO. EXTRA</u>	<u>RATE</u>	<u>FEE</u>		<u>RATE</u>	<u>FEE</u>	
BASIC FEE				\$345	\$	OR	\$690	\$ 690
TOTAL CLAIMS	<u>22</u>	<u>-20 = 2</u>		x9 =	\$	OR	x18 =	\$ 36
INDEP CLAIMS	<u>3</u>	<u>-03 = 0</u>		x39 =	\$	OR	x78 =	\$ 0
[] Multiple Dependent Claim Presented				\$130 =	\$	OR	\$260 =	\$
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CHEVRON-FREE FLC DEVICE

by Jiuzhi Xue, Beth L. Ellis, Stephen H. Perlmutter and Charles Crandall

BACKGROUND OF THE INVENTION

5 The present invention relates generally to optical devices based on liquid crystals and more specifically to an optical device which is based on ferroelectric liquid crystal (FLC) materials and is generally free of chevron structures.

 Optical devices based on surface-stabilized ferroelectric liquid crystal (SSFLC) structures have gathered considerable scientific and commercial interest in recent years. As is well known in the art, when confined between a pair of substrates, FLC molecules tend to become oriented in layers, which are called smectic layers. In the Smectic C
10 phase, the long axis, or director, of each FLC molecule is generally tilted at an angle with respect to the smectic layers.

 Turning now to the drawings, wherein like components are indicated by like reference numbers throughout the various figures, attention is immediately directed to FIG. 1A, which illustrates the smectic layer structure of an FLC material, generally indicated by reference number 10. As can be seen in FIG. 1A, FLC molecules 20 of FLC material 10
15 form smectic layers 22, with the director of each FLC molecule being tilted at an angle θ_0 with respect to smectic layers 22. Although this angle θ_0 with respect to the smectic layers remains constant among the FLC molecules, the director orientation of the FLC molecules rotates on a conical surface 24 with cone angle θ_0 through the successive layers. In other words, FLC molecules 20 have a natural tendency to form a helical structure along an axis 28 with each FLC molecule lying in a slightly displaced position on the conical surface 24 relative to FLC molecules in adjacent layers. It
20 should be noted that each FLC molecule possesses a polarization 26 which is perpendicular to the director of the molecule. The presence of polarization 26 becomes important when an electric field is applied across the FLC material, as will be described hereinafter at an appropriate point in the discussion.

 Turning now to FIG. 1B, the suppression of the formation of helical structures in an SSFLC device is illustrated. FLC material 10 is confined between parallel substrates 32. When the spacing between the substrates is reduced to a few microns, the helical rotation of the director through the layers is prevented by the interaction of the
25 molecules with the inner surfaces of the confining substrates. As shown in FIG. 1B, FLC molecules 20 in an SSFLC configuration become confined to one of two positions, A and B, which are parallel to the substrates on a cross section parallel to the substrate surfaces of a conical surface 24' with cone angle θ . The cone angle θ is generally smaller than θ_0 due to the interaction of the FLC molecules with the substrates. Smectic layers 22' are also of a slightly different width in comparison to smectic layers 22 of FIG. 1A due to the difference in cone angles. The projection of the director
30 of each FLC molecule 20 onto the plane of substrate 32 is shown as line 20'. It should be noted that each projection, represented by line 20', makes an angle θ with respect to a line 28', which is a projection of axis 28 onto the plane of substrate 32. As shown in FIG. 1B, the projection of the director of an FLC molecule in position B makes an angle 2θ with respect to the projection of the director of an FLC molecule in position A.

The two molecular positions A and B give rise to two possible optical states in the SSFLC device. Due to the symmetry of the system, the FLC molecules are generally stable in either of these optical states, and, as a result, the SSFLC device produces bistable optical states. The molecular positions A and B are respectively associated with the DOWN orientation of polarization 26 and the UP orientation of polarization 26 indicated by arrows 34 and 36, respectively. Since polarization 26 of each FLC molecule 20 tends to align along the direction of an electric field applied across the FLC material, the molecular position of the FLC molecule can be switched between positions A and B on conical surface 24' by applying an electric field in the UP direction or in the DOWN direction. In this way, the SSFLC device can be switched between the two optical states by applying an electric field across the FLC molecules between the substrates in the UP and DOWN directions.

Conventional SSFLC structures have certain inherent drawbacks. One such drawback is the fact that the device can only be in one of two optical states. Unlike nematic liquid crystal (NLC) devices, which is capable of analog operation by generating a continuum of optical states between a minimum and a maximum state according to the magnitude of the electric field applied across the NLC material, SSFLC devices are limited to binary operation in which one of two optical states is generated according to whether a positive or negative magnitude electric field is applied across the FLC material. Since molecular positions between positions A and B are not stable, optical states between the two stable states are not controllably accessible in a conventional SSFLC device. This inflexibility can be problematic especially in applications in which analog operation is desired.

Still another problem seen in the conventional SSFLC device is the presence of chevron structures. As commonly known in the art, chevron structures form in SSFLC devices due to the shrinkage of the smectic layers during the transition from a Smectic A (Sm A) phase to a Smectic C (Sm C) phase. Generally, in the assembly of a new SSFLC device, an FLC material is injected into the space between confining, parallel substrates at an elevated temperature such that the FLC material is in an isotropic phase. The SSFLC device is then gradually cooled such that the FLC material transitions from the isotropic phase through nematic and smectic phases. The smectic layers normally form when the FLC material is in the Sm A phase while the device temperature is still higher than room temperature. In the Sm A phase, the smectic layers are formed in the FLC material and the directors of the FLC molecules align perpendicularly to the smectic layers. As the SSFLC device is further cooled to room temperature the FLC material transitions to a chiral Smectic C (Sm C*) phase, in which the directors of the FLC molecules become tilted with respect to the smectic layers and are aligned on the conical surfaces. The smectic layers shrink slightly during the transition from the Sm A phase to the Sm C* phase due to the tilting of the FLC molecules with respect to the smectic layers. Due to conservation of mass and the structural boundary conditions, the shrinkage of the smectic layers results in the formation of chevron structures. The discontinuities between distinct domains of chevron structures pointing in opposing directions are optically visible as a zigzag pattern in the SSFLC device. Consequently, the presence of chevron structures gives rise to nonuniformity in the optical state produced by the device as a whole.

Prior efforts to eliminate the occurrence of chevron structures have included the application of an AC voltage pretreatment to the SSFLC device. The application of a predetermined AC voltage to the SSFLC device after the FLC material has been injected between the substrates has the effect of "kicking" the FLC molecules into uniform alignment, thus straightening the smectic layers and eliminating the chevron structures. The use of the AC voltage pretreatment

adds an extra step to the manufacturing process of the SSFLC device, thus leading to additional costs associated with the device assembly. Furthermore, the use of the AC voltage pretreatment often results in smectic layer undulation in the plane of the substrate, thus yielding an SSFLC device with lower contrast and generally poor performance.

Another approach for eliminating chevron structures is the use of special FLC materials that do not have a Sm A phase. These special materials have the property that no shrinking of the smectic layers takes place during the phase transition into the Sm C* phase, hence the occurrence of chevron structures is prevented. Unfortunately, such FLC materials are not commonly used in commercial applications because it is generally more difficult to achieve uniform alignment of these special FLC materials in comparison to conventional FLC materials. Also, there are fewer examples of these materials available commercially.

Another problem with the conventional SSFLC device is the instability of the two optical states associated with molecular positions A and B due to the fact that the FLC molecules adjacent to the inner surface of the substrates do not switch and also due to the presence of chevron structures.

Yet another drawback of the conventional SSFLC device is variation in the optical retardance of the device during switching between the two optical states. Referring again to FIG. 1B, although the helical structures are suppressed, FLC molecules 20 still tend to rotate about conical surface 24' in switching from position A to position B and vice versa in the direction of residual twist. This characteristic is commonly referred to as cone switching of FLC molecules. Since optical retardance of the SSFLC device is generally proportional to the length of the projection of the FLC molecule director onto the substrate plane, the symmetry of the system provides that the optical retardance of the SSFLC device when the FLC molecules are in position A is the same as that when the FLC molecules are in position B. However, the optical retardance changes during cone switching since the length of the projection of the FLC molecule director varies as the FLC molecule rotates around the cone. Although the switching between positions A and B normally takes 100 μ s or less, this effect of optical retardance variation can be problematic in certain applications requiring constant optical retardance.

In an effort to counter some of the aforescribed problems of the conventional SSFLC device, Kitayama discloses in U.S. Pat. No. 4,778,259 a method for stabilizing the optical states of an SSFLC structure. By offsetting the alignment axes of the top and bottom substrates by a small, non-zero angle, an additional molecular twist is introduced in the FLC material to counter the aforementioned, inherent twist of the FLC, thus further stabilizing the optical states of the resulting SSFLC device. Kitayama also uses an AC voltage treatment to achieve full cone switching (i.e., use the full cone angle of θ_0 rather than $\theta < \theta_0$). In U.S. Pat. No. 5,172,257, Patel takes the idea of the offset twist further by orienting the alignment axes of the alignment layers formed on the top and bottom substrates perpendicularly to one another. The alignment layers provide "strong anchoring" of the FLC molecules adjacent to the alignment layers such that the FLC molecules align in one of the two stable positions in parallel to the respective alignment axes with a 90° angle between the molecules near the top surface and those near the bottom surface. Thus, the natural twist of the FLC molecules is enhanced and an FLC device analogous to a twisted nematic device is achieved. The device disclosed in Patel is capable of exhibiting grayscale by continuously varying the applied electric field, thus changing the twist of the FLC molecule between the top and bottom substrates. In other words, the FLC device according to Patel is an analog

device, which is capable of exhibiting continuously variable, not bistable, optical states. However, it is submitted that the device disclosed in Patel has a number of disadvantages. A special FLC material with $\theta_0 = 45^\circ$ is required and the overall device tends to exhibit multiple domains that must be made uniform by use of an AC voltage pre-treatment. In addition, neither Kitayama nor Patel specifically addresses the problems of chevron structures and optical retardance variation in SSFLC devices.

As will be seen hereinafter, the present invention provides a heretofore unseen and highly advantageous approach with regard to achieving an FLC-based optical device while eliminating the problems present in prior art display systems.

SUMMARY OF THE INVENTION

As will be described in more detail hereinafter, an optical device including a ferroelectric liquid crystal material is herein disclosed. In one aspect of the invention, the optical device includes a first and a second substrate. A first alignment treatment is applied to a surface of the first substrate, the first alignment treatment being intended to induce an orientation of at least a portion of the ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to the first substrate. A second alignment treatment is applied to a surface of the second substrate, the second alignment treatment being intended to induce an orientation of at least another portion of the ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to the second substrate. The optical device further includes an arrangement for securing the first substrate with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other. In addition, a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate such that, the ferroelectric liquid crystal material being injected between the first and second substrates, the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device.

In another aspect of the invention, the optical device as described above is used in an optical system. The optical system further includes a light input directed at the optical device in such a way that the optical device in turn produces a light output of a particular optical state. Still further, the optical system includes an arrangement for electrically addressing the optical device in such a way that the particular optical state of the light output is continuously variable between a minimum optical state and a maximum optical state wherein an optical retardance of the optical device remains generally constant during the continuous variation of the optical state of the light output.

In still another aspect of the invention, a method for preventing formation of chevron structures in an optical device including a ferroelectric liquid crystal material is disclosed. Accordingly, a first and a second substrate are provided. A first alignment treatment is applied to a surface of the first substrate, the first alignment treatment being intended to induce an orientation of at least a portion of the ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to the first substrate. A second alignment treatment is applied to a surface of the second substrate, the second alignment treatment being intended to induce an orientation of

at least another portion of the ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to the second substrate. The first substrate is secured with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other. In addition, the first and second substrates are oriented in such a way that a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate. The ferroelectric liquid crystal material is injected between the first and second substrates such that the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device.

BRIEF DESCRIPTION OF THE DRAWINGS

The features of the present invention may best be understood by reference to the following descriptions of the embodiments together with the accompanying drawings.

FIG. 1A is a perspective, partial cut-away view, in elevation, of an FLC material shown here to illustrate a helical structure formed by conventional FLC molecules through smectic layers.

FIG. 1B is a perspective, partial cut-away view, in elevation, of an SSFLC device shown here to illustrate the suppression of the helical structure of the FLC molecules in the SSFLC device.

FIG. 2 is a perspective, partial cut-away view, in elevation, of one embodiment of an FLC device manufactured in accordance with the present invention shown here to illustrate the alignment of the FLC molecules in the device.

FIG. 3 is a partial cut-away view, in cross-section, of a portion of the FLC device of FIG. 2 shown here to illustrate details of an FLC molecule alignment near a substrate.

FIG. 4. is a perspective, partial cut-away view, in cross-section, of a test FLC device manufactured in accordance with the present invention.

FIG. 5. is a graph of transmission ratio (T/T_{\max}) as a function of applied voltage for the test device of FIG. 4 shown here to illustrate the electro-optic response of the test device.

DETAILED DESCRIPTION OF THE PREFERRED EMBODIMENTS

Attention is now directed to FIG. 2, which illustrates one embodiment of an FLC device, generally indicated by the reference number 100. FLC device 100 includes FLC material 10 confined between a top substrate 32A and a bottom substrate 32B. FLC device 100 also includes an alignment treatment 110A on the inner surface of top substrate 32A and an alignment treatment 110B on the inner surface of bottom substrate 32B. Alignment treatment 110A is designed to induce a predetermined molecular alignment of the portion of the FLC molecules which are located near the top substrate. Alignment treatment 110B is designed to induce a different, predetermined molecular alignment of the portion of the FLC molecules which are located near the bottom substrate. Alignment treatment 110A induces a

molecular alignment such that the projection onto top substrate 32A of the director of an FLC molecule located immediately adjacent to top substrate 32A is oriented in a direction A' as shown in FIG. 2. Alignment treatment 110B induces a different molecular alignment such that the projection onto top substrate 32A of the director of an FLC molecule located immediately adjacent to bottom substrate 32B is oriented in a direction B'.

Induced molecular alignment directions at the top and bottom substrates are oriented in such a way that direction B' makes an angle Ω with direction A', as shown in FIG. 2. Angle Ω is chosen such that $\Omega \neq 0^\circ$ nor 180° , and, preferably, the value of Ω is selected such that $\Omega \geq 2\theta$. In this way, an offset is induced in the alignment of the FLC molecular directors near the top substrate and those near the bottom substrates.

The FLC molecules which are located away from top and bottom substrates 32A and 32B are aligned at different orientations between directions A' and B' on conical surfaces 24'. In other words, FLC molecules 20 gradually transition from being oriented in direction A' near top substrate 32A to being oriented in direction B' near bottom substrate 32B by rotating through the angle Ω . Substrates 32A and 32B, including alignment treatments 110A and 110B, respectively, are assembled together such that the surfaces, on which alignment treatments are located, face each other and are spaced apart with uniform spacing between the substrates. The uniform spacing may be achieved by using conventional liquid crystal processing techniques such as, for example, the use of spacer spheres distributed between the substrates.

Turning briefly to FIG. 3, which is a partial cut-away, cross-sectional view of a portion of FLC device 100 of FIG. 2, details of the alignment of an FLC molecule located immediately adjacent to alignment treatment 110A is illustrated. In addition to inducing a director alignment in direction A' as shown in FIG. 2, alignment treatment 110A is also designed to induce a molecular pretilt of angle α , from a plane parallel to top substrate 32A. Alignment treatment 110B is similarly designed to ensure director alignment of FLC molecules located near bottom substrate 32B in direction B' with a pretilt angle α_2 . It should be noted that the pretilt angles at the top and bottom substrates may be configured to be equal such that $\alpha_1 = \alpha_2$.

The combination of the induced director orientation offset angle Ω between the top and bottom substrates and the FLC molecular pretilt angle α_1 or α_2 near the alignment treatment surfaces in the present embodiment works to break the aforescribed symmetry between the bistable positions A' and B' of FLC molecules 20 on conical surface 24' in such a way that position A' is favored near the top substrate and position B' is favored near the bottom substrate during the smectic layer shrinkage process. In addition, since the rotation of the FLC molecules from the top substrate to the bottom substrate in effect results in a pre-stretching of the smectic layers in the Sm A phase, additional shrinkage of the smectic layers during the transition into the Sm C* phase is minimized. As a result, the FLC device of the present invention is remarkably free of chevron structures. No additional pre-treatment, such as the application of an AC voltage, is required to eliminate chevron structures. Furthermore, conventional FLC materials (i.e., materials with a Sm A phase) can be used in the aforescribed embodiment since the specification of the offset angle Ω and pretilt angle α will result in an essentially chevron-free FLC device

Turning now to FIG. 4, a schematic of one of a series of test FLC devices manufactured in accordance with the present invention is illustrated. The test FLC device, generally indicated by reference numeral 300, includes a top substrate 332A and a bottom substrate 332B. Transparent glass substrates are used in the test device. Other substrates such as, for example, silicon substrates may also be used. The top and bottom substrates of the test device include transparent electrodes 334A and 334B, respectively.

Continuing to refer to FIG. 4, the top and bottom substrates further include alignment layers 310A and 310B, respectively. In the test device, a thin film of a polyimide material (SE610 manufactured by Nissan) is used as the alignment layer material. The polyimide film is formed on the ITO-coated substrates by spin-coating the cleaned substrates with a 2% solution of the polyimide material with the spin coater set at 3500 RPM for 30 seconds. The polyimide-coated substrates are pre-baked at 80°C for 15 minutes then post-baked at 250°C for 60 minutes. The thickness of the resulting polyimide film is approximately 200 Å. The baked substrates are cooled, then the coated surfaces are uni-directionally rubbed using a buffing wheel at a rubbing density of 150 and pile contact of approximately 450 μm (rubbing density being defined as the ratio of the speed of the buffing wheel to the speed of the stage on which the substrate is placed). The direction in which the alignment layer is rubbed determines the orientation of the FLC molecular director induced at the substrate. The polyimide film also induces a molecular pretilt of $\alpha \approx 7^\circ$ from a plane parallel to the substrate surface.

Still referring to FIG. 4, top and bottom substrates 332A and 332B are brought together and secured with the coated surfaces facing each other and a uniform spacing between the substrates in a cell configuration. The substrates of the illustrated test device are oriented such that the rubbing directions of the top and bottom substrates form an angle of 45° with respect to each other (i.e., the angle between the rubbing direction A' and rubbing direction B' makes the angle $\Omega = 45^\circ$). In the test device, uniform spacing is achieved by spraying spherical spacers of 1 μm diameter over one of the substrates before bringing the substrates together, as is commonly done in liquid crystal device processing. A perimeter sealant secures the two substrates together while leaving small openings for injection of the FLC material.

The space between the assembled substrates is filled with a commercial FLC material (CS1025 available from Chisso Chemicals) in the isotropic phase in a vacuum fill chamber. CS1025 has a cone angle of $\theta_0 = 22^\circ$ in the Sm C* phase at room temperature and has the following phase sequence (the transition temperatures are indicated in parentheses):

Isotropic \rightarrow Chiral Nematic (N*) \rightarrow Sm A \rightarrow Sm C* \rightarrow Crystalline
(94°C) (84°C) (62°C) (-3°C)

The filled test device is gradually cooled at a controlled rate of approximately 1°C/minute. The FLC material transitions through the nematic and Sm A phases during the cool down process to result in the Sm C* phase at room temperature. Finally, electronic leads 340 are attached to electrodes 334A and 334B to allow the connection of a voltage source 342 to the final FLC device. When voltage source is activated to produce a voltage difference between the top and bottom electrodes, an electric field associated with the voltage difference is applied across the FLC material therebetween.

Although a specific device fabrication procedure is described, it should be understood that the device fabrication procedure described above is only one example of manufacturing an FLC device in accordance with the present invention, and equivalent devices may be achieved in a wide variety of ways. For instance, other suitable materials, such as, but not limited to, a thin film of polyvinyl alcohol, nylon or obliquely evaporated silicon dioxide, that provides a known molecular pretilt may be used in place of the polyimide as the alignment layer material. Furthermore, the aforescribed processing procedure for the polyimide material is only one of any number of possible processing procedures to controllably achieve a variety of molecular pretilt angles. For example, the specific details of the coating, curing and rubbing procedures may be varied to obtain molecular pretilt angles other than a $\alpha \approx 7^\circ$. Variation in the molecular pretilt angle may be desired when using an alternative FLC material other than CS1025, such as, for example, CS1026 or SCE-7. For instance, it has been found through testing of the structure of the present invention using experimental FLC mixtures that FLC mixtures with three phenyl rings in the molecular structure is particularly suited for the present invention. Still further, other combinations of molecular pretilt angle α and rubbing direction offset angle Ω values, other than those values used in the test FLC device, may also be used while remaining within the scope of the present invention.

Remarkably, when examined under a polarizing microscope without an applied voltage from voltage source 342, the test device as illustrated in FIG. 4 exhibits no zigzag patterns, which are indicative of the presence of chevron structures and shows a uniform bluish color across the aperture of the device. These observations indicate that the device includes a layer of FLC material of a uniform thickness and is essentially free of chevron structures. Moreover, when a voltage is applied across the FLC material, no layer damage nor other known defects are observed using the polarizing microscope, thus further indicating the absence of chevron structures.

When an electric field is applied between the top and bottom substrates of test FLC device 300, the test FLC device exhibits a unique, unanticipated optical behavior. The test FLC device manufactured in accordance with the present invention exhibits a continuous variation of optical states depending on the strength of the applied electric field. Furthermore, the optical retardance of the test FLC device remains essentially constant during the optical state variation, as will be described in detail immediately hereinafter.

In addition to inducing a particular FLC molecular director orientation with a pretilt angle, the alignment treatments on the top and bottom substrates are designed to provide strong anchoring of the FLC molecules in the intended orientation directions. A strong surface interaction between the alignment treatments and the FLC molecules immediately adjacent to the alignment treatments ensures that the FLC molecules in close proximity of the substrates are generally anchored with their directors pointing along the intended orientation directions. Strong molecular anchoring is evidenced in the present embodiment by the fact that a $+\Omega$ angle from direction A' to direction B' produces the same optical response from the device as an angle $-\Omega$ from direction A' to direction B' when an electric field is applied across the FLC material. This characteristic is in contrast to the weak molecular anchoring indicated in the prior art device of Kitayama since, in the device of Kitayama, the offset angle must be set at a small, non-zero angle to balance the polar surface anchoring of the substrates.

As described in the foregoing discussion, the polarization of the FLC molecules tend to align along the direction of applied electric field. The exact orientation of polarization 26, and hence the position of each FLC molecule 20 on conical surface 24', depends on the strength of the applied electric field and the proximity of that particular FLC molecule to the alignment treatments on the substrates. The strong anchoring of the FLC molecules near a substrate forces the FLC molecules immediately adjacent to an alignment treatment surface to remain in the position induced by the alignment treatment regardless of the applied electric field. The FLC molecules farther away from the substrates, however, are less constrained by their interaction with alignment treatments and will rotate about the conical surfaces to align with the applied electric field. Therefore, the polarization of FLC molecules around halfway between the two substrates will align with the applied electric field at smaller field magnitudes, and more FLC molecules will rotate at strong electric fields. As a result, the FLC device of the present invention exhibits a continuous variation of optical state depending on the strength of the applied electric field.

Furthermore, the Applicants have experimentally verified that the FLC device of the present invention exhibits essentially no change in optical retardance during optical state variation by application of electric field. This behavior is in contrast to that of conventional SSFLC devices in which the optical retardance changes during cone switching since the length of the projection of the FLC molecule director varies during rotation around the cone, and it is advantageous in applications that require constant optical retardance during device operation.

Turning now to FIG. 5 in conjunction with FIG. 4, the electro-optic response of the test FLC device is illustrated. FIG. 5 is a graph of the transmission ratio (T / T_{\max}) versus the applied voltage of the test FLC device of FIG. 4, the graph being generally indicated by reference numeral 400. The measurements are taken with the test FLC device placed between two polarizers with the optical axes of the polarizers arranged with respect to the test FLC device in such a way that a large applied voltage in the UP direction (-V) yields the minimum transmission ratio. As can be seen in graph 400, the transmission ratio gradually increases as the applied voltage is increased from less than -2V up to +2V. The increase in transmission ratio saturates at a value near 0.65 for applied voltage values larger than approximately +2V.

A significant characteristic of the electro-optic response as shown in FIG. 5 is the fact that the transmission ratio gradually increases from a minimum value (near 0.0) to a maximum value (near 0.65) with increasing applied voltage. The test FLC device is capable of yielding transmission ratios between the minimum and maximum values with the application of voltages between -2V and +2V.

The behavior of the test FLC device is in contrast to that of the aforescribed conventional SSFLC device. In the conventional SSFLC device, the FLC molecules are collectively switched between the A and B positions as shown in FIG. 1B by the application of an UP voltage, thus yielding only two possible optical states, such as a minimum and a maximum transmission ratio value respectively associated with the A and B positions. In other words, in the conventional SSFLC device, transmission ratio values between the minimum and maximum values are not accessible with the application of voltages between the minimum and maximum voltage values. However, the test FLC device is capable of yielding a continuum of optical states, that is, transmission ratio values, between the minimum and maximum values.

It should be noted that the fabrication procedure of the test FLC device outlined above is essentially the same as the normal fabrication procedure of conventional SSFLC devices. However, unlike conventional SSFLC devices, the proper choice of alignment layer material and alignment offset angle between the top and bottom substrates ensures that the FLC device according to the present invention is essentially free of chevron structures. Unlike the conventional SSFLC device, the test FLC device is essentially free of chevron structures and no change in optical retardance is observed during voltage application. Furthermore, the test FLC device manufactured in accordance with the present invention as shown in FIG. 4 is capable of analog operation by continuously varying the applied voltage between the minimum and maximum values. Still further, the aforescribed properties are achievable using commercially available FLC mixtures. These characteristics enable the use of the FLC device of the present invention to be used to display grayscale using conventional FLC materials.

Moreover, the FLC device according to the present invention may still be operated as a binary FLC device yielding two optically distinctive states (such as maximum and minimum transmission states). When used as binary FLC device, the FLC device of the present invention has the advantage that no defects related to the presence of chevron structures arise during operation. Specifically, defects such as "boat wakes," as is commonly known in the art, are eliminated.

To the Applicant's knowledge, such an FLC device as described above, which is generally free of chevron structures without a need for special materials or additional pre-treatment after the device has been assembled, is not available. In addition, the FLC device manufactured in accordance with the present invention is also capable of continuous optical state variation according to variation in the magnitude of the applied electric field. Furthermore, the FLC device of the present invention exhibits essentially no change in optical retardance during optical state variation.

Although each of the above described embodiments have been illustrated with the various components having particular respective orientations, it should be understood that the present invention may take on a variety of specific configurations with the various components being located in a wide variety of positions and mutual orientations and still remain within the scope of the present invention. Furthermore, suitable equivalents may be used in place of or in addition to the various components, the function and use of such substitute or additional components being held to be familiar to those skilled in the art and are therefore regarded as falling within the scope of the present invention. For example, photo-buffing, or the application of UV light at an oblique angle to an alignment layer, may be used to induce molecular alignment near the substrate surfaces. Therefore, the present examples are to be considered as illustrative and not restrictive, and the invention is not to be limited to the details given herein but may be modified within the scope of the appended claims.

What is claimed is:

1. An optical device including a ferroelectric liquid crystal material, said optical device comprising:

a first and a second substrate;

a first alignment treatment applied to a surface of the first substrate, said first alignment treatment being intended to induce an orientation of at least a portion of said ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to said first substrate;

a second alignment treatment applied to a surface of the second substrate, said second alignment treatment being intended to induce an orientation of at least another portion of said ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to said second substrate; and

means for securing the first substrate with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other and a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate such that, said ferroelectric liquid crystal material being injected between the first and second substrates, the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device.

2. An optical device of Claim 1 wherein said ferroelectric liquid crystal material has a phase sequence of Isotropic – Nematic – Smectic A – Crystalline states.

3. An optical device of Claim 1 wherein, said ferroelectric liquid crystal material having a cone angle θ , said non-zero angle Ω has a predetermined value such that $\Omega \geq 2\theta$ and $\Omega \neq 180^\circ$.

4. An optical device of Claim 1 wherein said first and second alignment treatments are specifically chosen so as to specifically induce pretilt angles of α_1 and α_2 , respectively.

5. An optical device of Claim 4 wherein said first alignment treatment includes a coating of a selected alignment material, said coating being applied, cured and treated so as to specifically induce the pretilt angle of α_1 .

6. An optical device of Claim 5 wherein said second alignment treatment includes a coating of another selected alignment material, said coating being applied, cured and treated so as to specifically induce the pretilt angle of α_2 .

7. An optical device of Claim 4 wherein each of said pretilt angles is at most 10° .

8. An optical device of Claim 4 wherein said first and second alignment treatments are generally identical.

9. An optical device of Claim 1 wherein said first and second alignment treatments provide strong molecular anchoring of at least portions of the ferroelectric liquid crystal material located immediately adjacent to the treated surfaces of the first and second substrates.

10. An optical device of Claim 1 further comprising:

5 a light input directed at said optical device in such a way that the optical device in turn produces a light output of a particular optical state; and

means for electrically addressing said optical device in such a way that the particular optical state of the light output is continuously variable between a minimum optical state and a maximum optical state.

10 11. An optical device of Claim 10 wherein an optical retardance of the optical device remains generally constant during said continuous variation of the optical state of the light output.

12. An optical device of Claim 1 wherein said first substrate includes a reflective surface.

13. An optical system comprising:

an optical device including

a ferroelectric liquid crystal material,

15 a first and a second substrate,

a first alignment treatment applied to a surface of the first substrate, said first alignment treatment being intended to induce an orientation of at least a portion of said ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to said first substrate,

20 a second alignment treatment applied to a surface of the second substrate, said second alignment treatment being intended to induce an orientation of at least another portion of said ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to said second substrate, and

25 means for securing the first substrate with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other and a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate such that, said ferroelectric liquid crystal material being injected between the first and second substrates, the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device;

30 a light input directed at said optical device in such a way that the optical device in turn produces a light output of a particular optical state; and

means for electrically addressing said optical device in such a way that the particular optical state of the light output is continuously variable between a minimum optical state and a maximum optical state wherein an optical retardance of the optical device remains generally constant during said continuous variation of the optical state of the light output.

14. In an optical device including a ferroelectric liquid crystal material, a method for preventing formation of chevron structures in the optical device, said method comprising the steps of:

providing a first and a second substrate;

applying a first alignment treatment to a surface of the first substrate, said first alignment treatment being intended to induce an orientation of at least a portion of said ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to said first substrate;

applying a second alignment treatment to a surface of the second substrate, said second alignment treatment being intended to induce an orientation of at least another portion of said ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to said second substrate;

securing the first substrate with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other and a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate; and

injecting the ferroelectric liquid crystal material between the first and second substrates such that the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device.

15. The method of Claim 14 further comprising the step of selecting a ferroelectric liquid crystal material having a phase sequence of Isotropic – Nematic – Smectic A – Crystalline states.

16. The method of Claim 14 wherein, said ferroelectric liquid crystal material having a cone angle θ , said step of securing the first substrate with respect to the second substrate includes the step of specifying the value of angle Ω to have a value such that $\Omega \geq 2\theta$ and $\Omega \neq 180^\circ$.

17. The method of Claim 14 further comprising the step of choosing said first and second alignment treatments so as to specifically induce pretilt angles of α_1 and α_2 , respectively.

18. The method of Claim 17 wherein said step of applying the first alignment treatment to a surface of the first substrate further includes the steps of:

coating the surface with a selected alignment material;

curing said coated surface using a heating and cooling sequence; and

rubbing said cured, coated surface using a buffing material in such a way that at least a portion of said ferroelectric liquid crystal material tends to become orientated of along the first alignment direction with the first pretilt angle α_1 with respect to the plane parallel to said first substrate.

19. The method of Claim 18 said step of applying the second alignment treatment to a surface of the second substrate further includes the steps of:

coating the surface with another selected alignment material;

curing said coated surface using another heating and cooling sequence; and

rubbing said cured, coated surface using a buffing material in such a way that at least another portion of said ferroelectric liquid crystal material tends to become orientated of along the second alignment direction with the second pretilt angle α_2 with respect to the plane parallel to said second substrate.

20. The method of Claim 17 wherein said step of applying the first alignment treatment to a surface of the first substrate and said step of applying the second alignment treatment to a surface of the second substrate are generally identical.

21. The method of Claim 17 wherein said choosing step further includes the step of taking into consideration molecular anchoring properties of said first and second alignment treatments so as to choose first and second alignment treatments to specifically induce pretilt angles of α_1 and α_2 , respectively, while providing strong molecular anchoring of at least portions of the ferroelectric liquid crystal material located immediately adjacent to the treated surfaces of the first and second substrates.

22. The method of Claim 14 further comprising the steps of:

providing a light input to said optical device in such a way that the optical device in turn produces a light output of a particular optical state; and

electrically addressing said optical device in such a way that the particular optical state of the light output is continuously variable between a minimum optical state and a maximum optical state.

ABSTRACT OF DISCLOSURE

An optical device includes a ferroelectric liquid crystal material. This optical device has a first and a second substrate. A first alignment treatment is applied to a surface of the first substrate, the first alignment treatment being intended to induce an orientation of at least a portion of the ferroelectric liquid crystal material along a first alignment direction with a first pretilt angle α_1 with respect to a plane parallel to the first substrate. A second alignment treatment is applied to a surface of the second substrate, the second alignment treatment being intended to induce an orientation of at least another portion of the ferroelectric liquid crystal material along a second alignment direction with a second pretilt angle α_2 with respect to a plane parallel to the second substrate. The optical device further includes an arrangement for securing the first substrate with respect to the second substrate in such a way that the surfaces of the first and second substrates onto which the first and second alignment treatments were applied, respectively, are spaced apart, generally parallel and facing each other. In addition, a projection of the first alignment direction onto the treated surface of the first substrate makes a non-zero angle Ω with respect to a projection of the second alignment direction onto the treated surface of the first substrate such that, the ferroelectric liquid crystal material being injected between the first and second substrates, the optical device is free of chevron structures without a need to otherwise apply an additional treatment to the optical device.

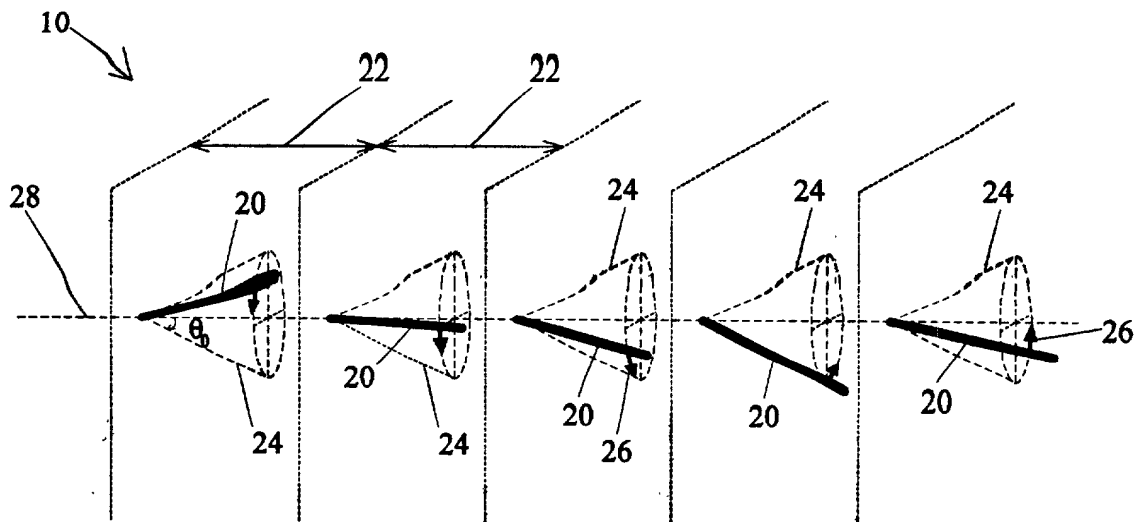


FIG. 1A

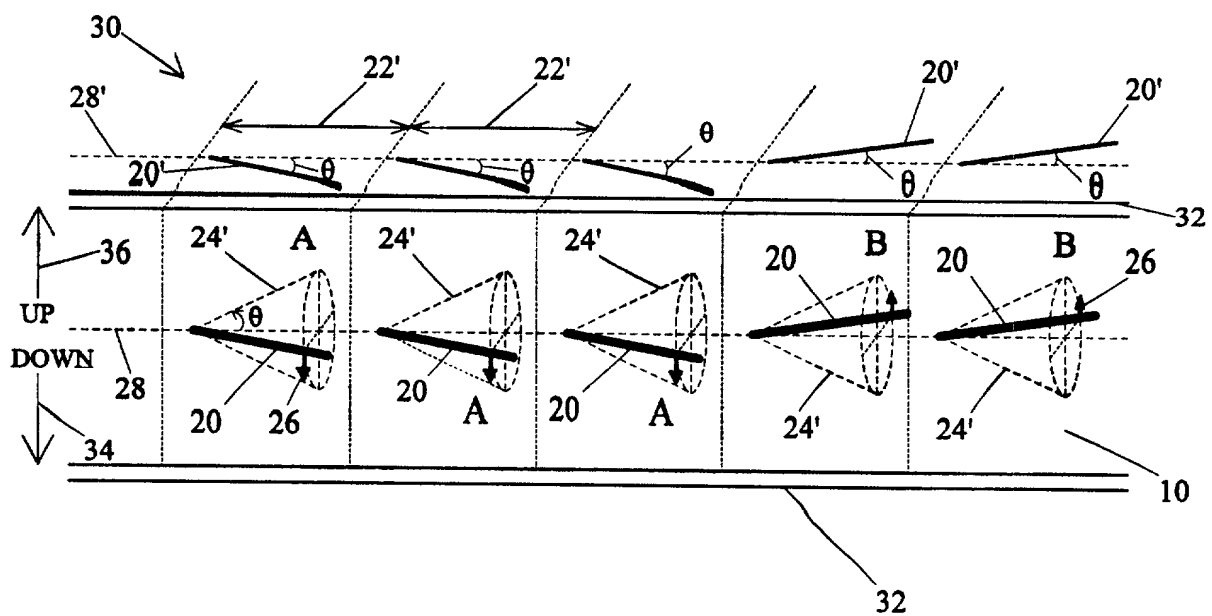


FIG. 1B

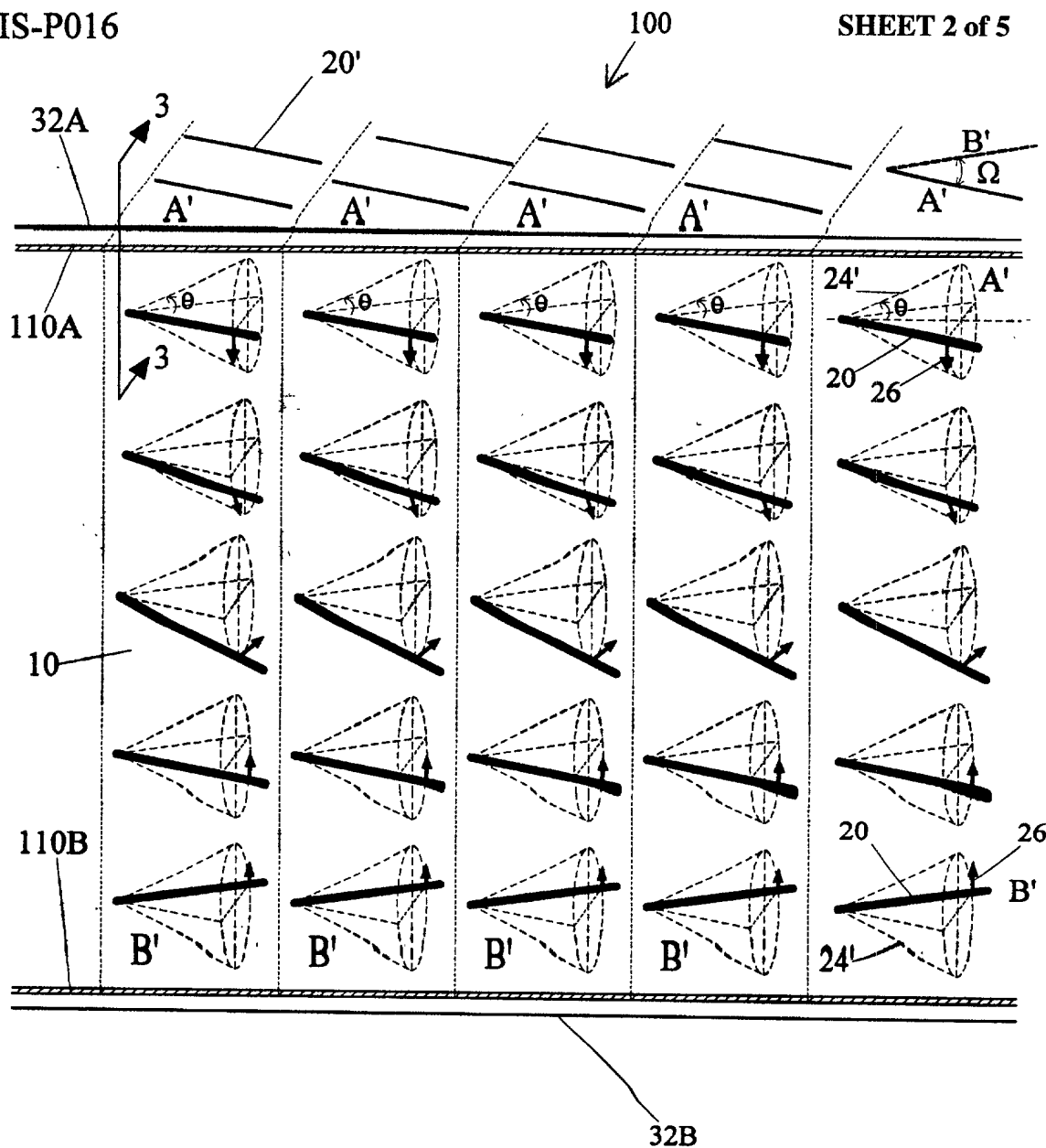


FIG. 2

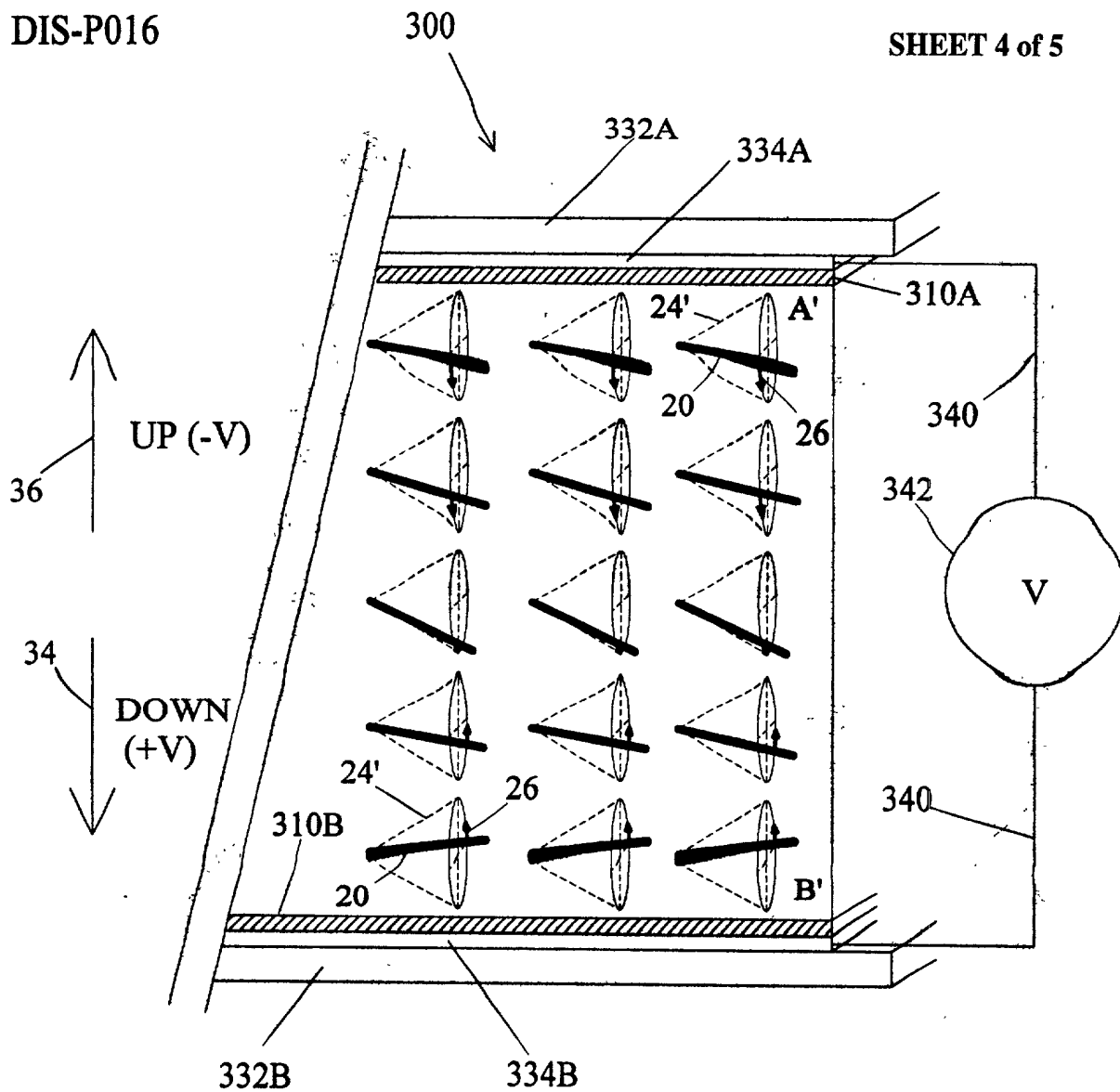


FIG. 4

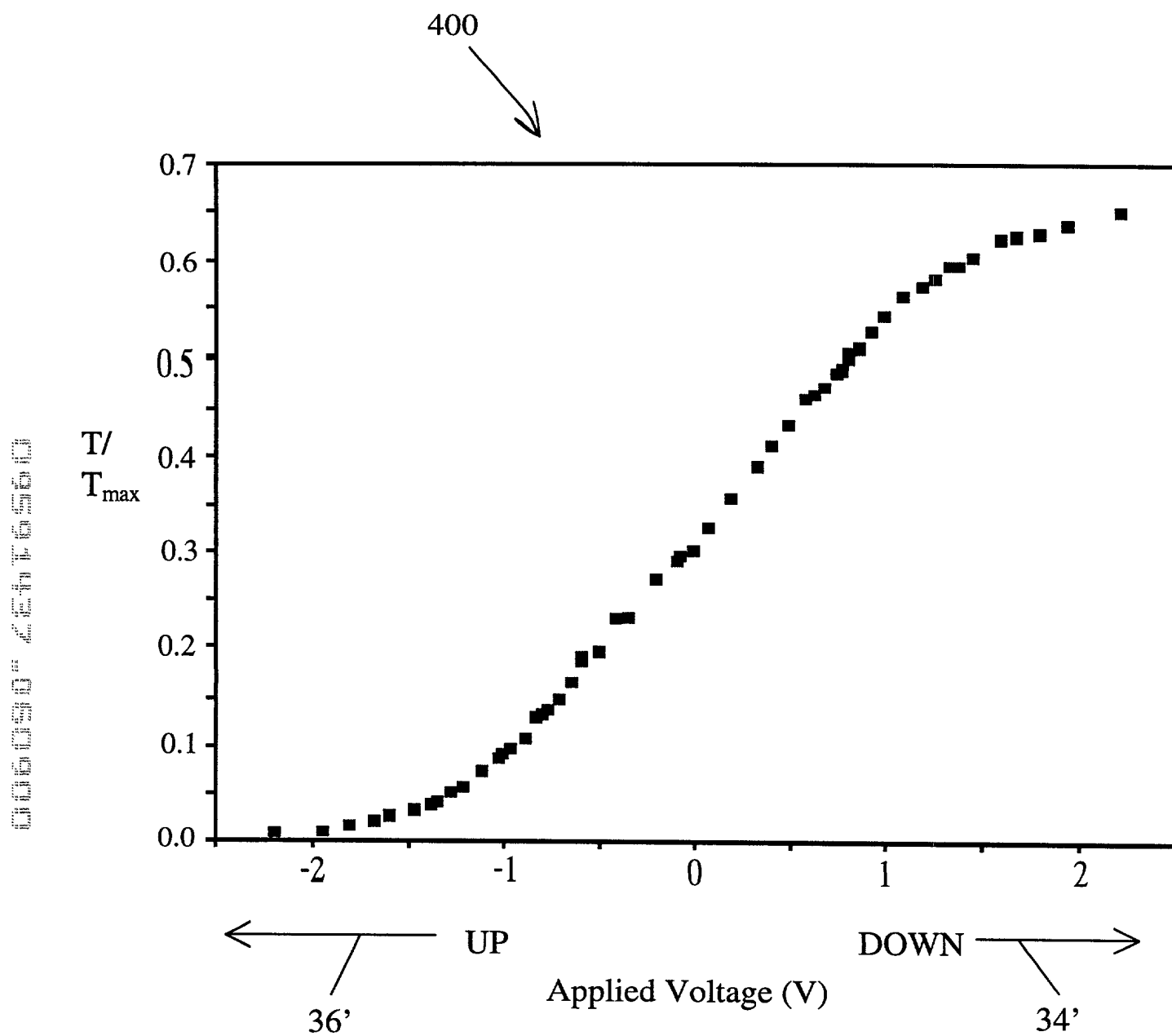


FIG. 5

COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or an original, first, and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled **CHEVRON-FREE FLC DEVICE** the specification of which

 X is attached hereto.
 was filed on _____ as
United States Application Number _____
or PCT International Application Number _____
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above. I do not know and do not believe that the claimed invention was ever known or used in the United States of America before my invention thereof, or patented or described in any printed publication in any country before my invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, and that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months (for a utility patent application) or six months (for a design patent application) prior to this application.

I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, Section 119(a)-(d), of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>			<u>Priority Claimed</u>	
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Day/Month/Year Filed)	<u> </u> Yes	<u> </u> No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Day/Month/Year Filed)	<u> </u> Yes	<u> </u> No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Day/Month/Year Filed)	<u> </u> Yes	<u> </u> No

I hereby claim the benefit under title 35, United States Code, Section 119(e) of any United States provisional application(s) listed below

<u> </u> (Application Number)	<u> </u> Filing Date
<u> </u> (Application Number)	<u> </u> Filing Date

I hereby claim the benefit under Title 35, United States Code, Section 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, Section 112, I acknowledge the duty to disclose all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

_____ (Application Number)	_____ Filing Date	_____ (Status -- patented, pending, abandoned)
_____ (Application Number)	_____ Filing Date	_____ (Status -- patented, pending, abandoned)

I hereby appoint the practitioners associated with the Customer Number provided below, with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected herewith, and direct that all correspondence be addressed to that Customer Number.

Customer Number 21833

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Inventor's Signature: _____ Date: _____

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Title 37, Code of Federal Regulations, Section 1.56
Duty to Disclose Information Material to Patentability

(a) A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty to disclosure information exists with respect to each pending claim until the claim is canceled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability of a claim that is canceled or withdrawn from consideration need not be submitted if the information is not material to the patentability of any claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability of any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practiced or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine:

- (1) Prior art cited in search reports of a foreign patent office in a counterpart application, and
- (2) The closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office.

(b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made or record in the application, and

- (1) It establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or
- (2) It refutes, or is inconsistent with, a position the applicant takes in:
 - (i) Opposing an argument of unpatentability relied on by the Office, or
 - (ii) Asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden-of-proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability.

(c) Individuals associated with the filing or prosecution of a patent application within the meaning of this section are:

- (1) Each inventor named in the application;
- (2) Each attorney or agent who prepares or prosecutes the application; and
- (3) Every other person who is substantively involved in the preparation or prosecution of the application and who is associated with the inventor, with the assignee or with anyone to whom there is an obligation to assign the application.

(d) Individuals other than the attorney, agent or inventor may comply with this section by disclosing information to the attorney, agent, or inventor.